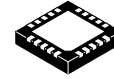


Wired M-BUS Slave Transceiver with Low Power Mode Support

NCN5151



NQFP-20
MN SUFFIX
CASE 485E

Description

The NCN5151 is a single-chip integrated slave transceiver for use in two-wire Meter Bus (M-BUS) slave devices and repeaters.

The NCN5151 reuses the NCN5150 features and adds two low power modes: a 2-wire low power mode dedicated to System for meter Communication and Readout for powerless meters (SCR) and a 3-wire low power mode allowing support for wireless applications. When configured in low power mode, the transceiver will not behave anymore as a constant current source in order to save energy.

When configured and used in M-BUS mode, the NCN5151 transceiver provides all of the functions needed to satisfy the European Standards EN 13757-2 and EN 1434-3 describing the physical layer requirements for M-BUS. It includes a programmable power level of up to 6 unit loads, which are available for use in external circuits through a 3.3 V LDO regulator.

Features

- Single-chip M-BUS Transceiver
- 2 and 3-Wire Low Power Modes with Selection Input Pins
- Integrated 3.3 V VDD LDO Regulator with Extended Peak Current Capability of 15 mA
- Supports Powering Slave Device from the Bus
- Adjustable Constant Current Sink Up to 6 Unit Loads in M-Bus Mode
- Adjustable Current Limit up to 2 Unit Loads in Low Power Mode
- Current budget of 0.88 mA minimum for external circuits
- Low Turn-ON/OFF Levels for Low Bus Voltage Operation
- Polarity Independent
- Power-Fail Function (M-Bus mode)
- UART Communication Speeds up to 38400 baud
- Fast Startup – No External Transistor Required on STC Pin
- Industrial Ambient Temperature Range of -40°C to +85°C
- These are Pb-free Devices

Typical Applications

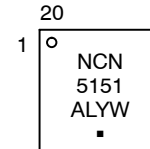
- Multi-Energy Utility Meters
 - ◆ Water
 - ◆ Gas
 - ◆ Electricity
 - ◆ Heating systems

Related Standards – European Standard

EN 13757-2, EN 1434-3

For more information visit www.m-bus.com

MARKING DIAGRAMS



A	= Assembly Location
L	= Wafer Lot (optional)
Y	= Year
W	= Work Week
■	= Pb-free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 20 of this data sheet.

NCN5151

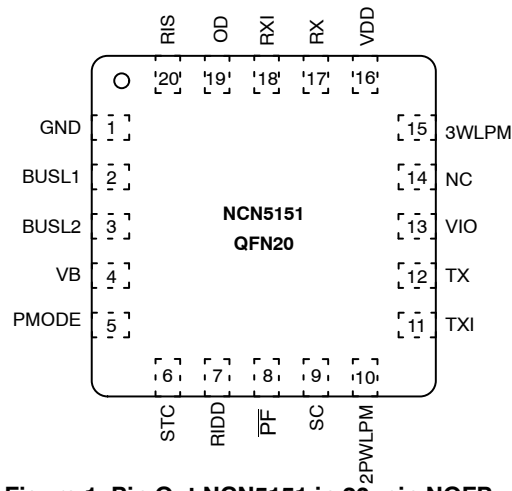


Figure 1. Pin Out NCN5151 in 20-pin NQFP (Top View)

Table 1. NCN5151 PINOUT

Signal Name	Type	Pin Number	Pin Description
GND	Ground	1	Ground
BUSL1	Bus	2	Bus line. Connect to bus through series resistors. Connections are polarity independent.
BUSL2	Bus	3	
VB	Power	4	Rectified bus voltage
PMODE	Output	5	Power Mode output indicating the voltage level on VB pin
STC	Output	6	Storage capacitor pin. Connect to bulk storage capacitor (typically 100 μ F – 470 μ F, minimum 10 μ F).
RIDD	Input	7	Mark current adjustment pin. Connect to programming resistor.
PF	Output	8	Power Fail, active low (disabled in low power mode)
SC	Output	9	Mark bus voltage level storage capacitor pin. Connect to ceramic capacitor (typically 220 nF).
2WLPM	Input	10	2-Wire Low Power Mode selection input
TXI	Output	11	UART Data output (inverted)
TX	Output	12	UART Data output
VIO	Input	13	I/O pins (RX, RXI, TX, TXI, PF) high level voltage
NC	–	14	Leave this pin floating.
3WLPM	Input	15	3-Wire Low Power Mode selection input
VDD	Power	16	Voltage regulator output. Connect to minimum 1 μ F decoupling capacitor.
RX	Input	17	UART Data input
RXI	Input	18	UART Data input (inverted)
OD	Output	19	Open Drain output (active low). Used for the slave to master communication in 3-Wire Low Power mode
RIS	Input	20	Modulation current adjustment pin

NCN5151

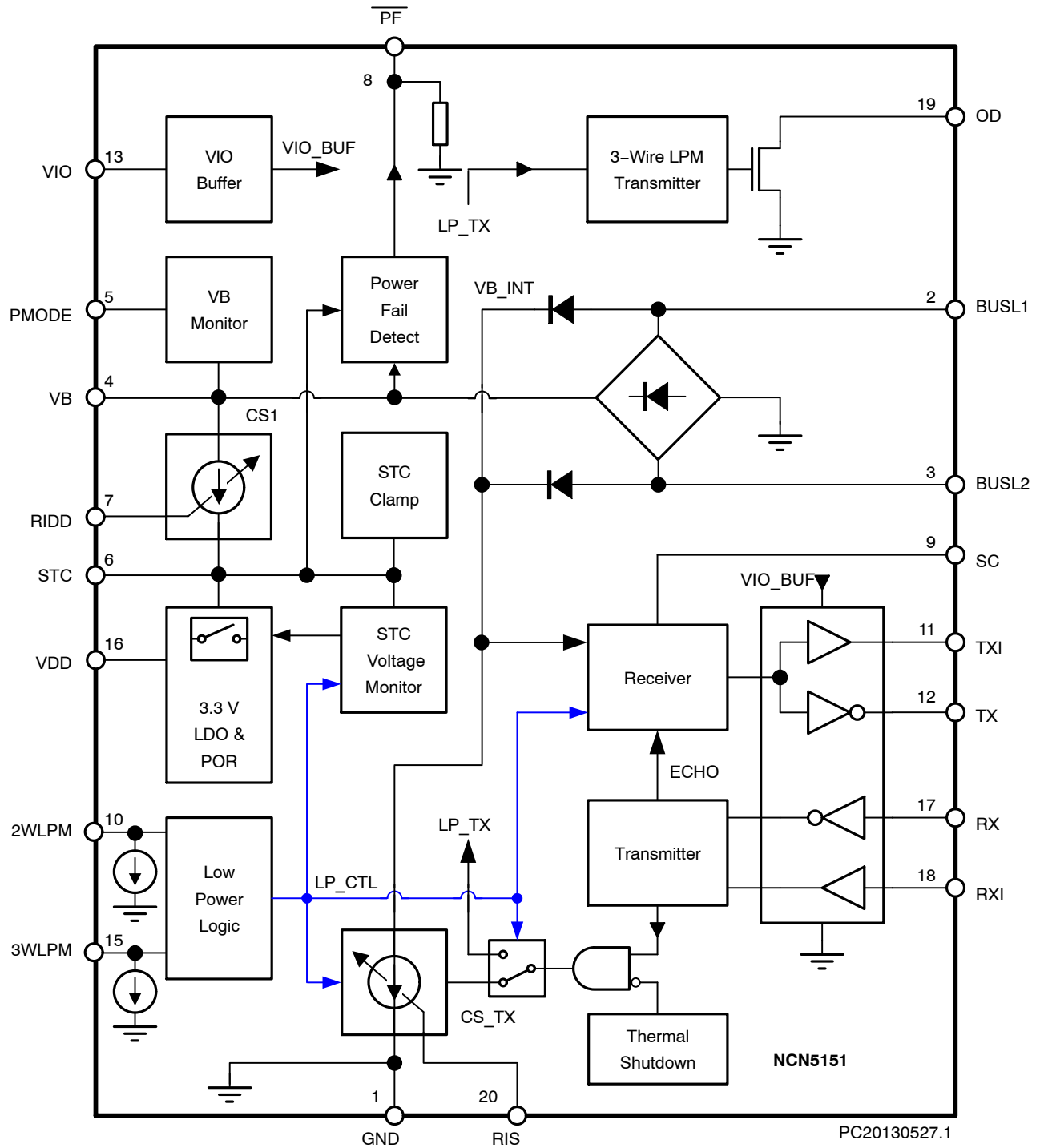


Figure 2. NCN5151 Block Diagram

Table 2. ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
T_J	Junction temperature	-40	+150	°C
T_S	Storage temperature	-55	+150	°C
V_{BUS}	Bus voltage (BUSL1 – BUSL2)	-50	50	V
V_{TX}, V_{TXI}	Voltage on pin TX, TXI	-0.3	7.5	V
V_{RX}, V_{RXI}, V_{IO}	Voltage on pin RX, RXI, VIO	-0.3	5.5	V
V_{OD}	Voltage on pin OD	-0.3	40	V
V_{3WLPM}	Voltage on pin 3WLPM	-0.3	3.6	V
V_{2WLPM}	Voltage on pin 2WLPM	-0.3	3.6	V
V_{PMODE}	Voltage on pin PMODE	-0.3	3.6	V
ESD _{HBM}	ESD Rating – Human Body Model	4.0	–	kV
ESD _{MM}	ESD Rating – Machine Model	250	–	V
ESD _{CDM}	ESD Rating – Charged Device Model	750	–	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. All voltages are referenced to GND.

Table 3. THERMAL CHARACTERISTICS

Symbol	Rating	Typical Value	Unit
$R_{\theta JA}$	Thermal Characteristics, QFN-20 Thermal Resistance, Junction-to-Air $R_{\theta JA}$ obtained with 2S2P test boards according to JEDEC JESD51 standard.	38	°C/W

Table 4. RECOMMENDED OPERATING CONDITIONS (Note 2)

Symbol	Parameter			Min	Max	Unit
T_A	Ambient Temperature			-40	+85	°C
V_{BUS}	Bus voltage (V _{BUSL1} –V _{BUSL2})	M-Bus mode	1–2 U_L	9.2	42	V
			3–6 U_L	9.7	42	V
		2 and 3–Low Power Mode	1–2 U_L	4.75	10	V
$V_{STC,LP}$	VSTC in Low Power Mode to guarantee min V_{DD} of 3.1 V @ $I_{DD} = 15$ mA peak			3.8		V
V_{IO}	VIO pin voltage (Note 3)			2.5	3.8	V
V_{OD}	OD pin voltage (Note 3)			0	10	V
ESD–HBM	Human Body Model (EIA–JESD22–A114–B)			4		kV
ESD–MM	Machine Model (JEDEC JESD22–A115)			200		V
ESD–CDM	Charged Device Model (EIA–JESD22–C101–A)			750		V
LU	Latch-up (EIA/JESD78)			±100		mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

2. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

3. All voltages are referenced to GND

Table 5. M-BUS MODE – ELECTRICAL CHARACTERISTICS (Notes 4 and 5)

Symbol	Parameter	Min	Typ	Max	Unit
ΔV_{BR}	Voltage drop over bus rectifier ($V_{BUS} - V_B$) with $R_{IDD} = 4.02 \text{ k}\Omega$			1.25	V
ΔV_{CS}	Voltage drop over CS1 ($V_B - V_{STC}$)	$R_{IDD} \leq 13 \text{ k}\Omega$	1.30		V
		$R_{IDD} \leq 4.02 \text{ k}\Omega$	1.70		
I_{BUS}	Total current drawn from the bus, in Mark State	$R_{IDD} = 30 \text{ k}\Omega$	1.30	1.50	mA
		$R_{IDD} = 13 \text{ k}\Omega$	2.70	3.00	
		$R_{IDD} = 8.45 \text{ k}\Omega$	4.10	4.50	
		$R_{IDD} = 6.19 \text{ k}\Omega$	5.50	6.00	
		$R_{IDD} = 4.87 \text{ k}\Omega$	6.80	7.50	
		$R_{IDD} = 4.02 \text{ k}\Omega$	8.20	9.00	
ΔI_{BUS}	Bus current stability (over $\Delta V_{BUS} = 10 \text{ V}$, $R_X/R_{XI} = \text{mark}$)		0.2	2	%
I_{STC}	Idle current available for the application to draw from STC and V_{DD} (including current drawn from V_{DD})	$R_{IDD} = 30 \text{ k}\Omega$	0.88	1.00	mA
		$R_{IDD} = 13 \text{ k}\Omega$	2.10	2.30	
		$R_{IDD} = 8.45 \text{ k}\Omega$	3.10	3.60	
		$R_{IDD} = 6.19 \text{ k}\Omega$	4.20	4.80	
		$R_{IDD} = 4.87 \text{ k}\Omega$	5.30	6.10	
		$R_{IDD} = 4.02 \text{ k}\Omega$	6.50	7.40	
$\Delta I_{STC,SPACE}$	Additional current available for the application when transmitting a space	–	250	–	μA
$V_{B,\overline{PF}}$	Threshold voltage on V_B to trigger $\overline{PF}$	$V_{STC} + 0.3$		$V_{STC} + 0.8$	V
$V_{\overline{PF},OH}$	$\overline{PF}$ voltage high ($I_{\overline{PF}} = -100 \mu\text{A}$)	$V_{IO} - 0.6$		V_{IO}	V
$V_{\overline{PF},OL}$	$\overline{PF}$ voltage low (Note 6) ($I_{\overline{PF}} = 50 \mu\text{A}$)	0		0.6	V

4. All voltages are referenced to GND
5. R_{IDD} resistor with 1% accuracy
6. $\overline{PF}$ pin is pulled down with an on-chip resistor of typically 2 M Ω

Table 6. LOW POWER MODE – ELECTRICAL CHARACTERISTICS (Note 7)

Symbol	Parameter	Min	Typ	Max	Unit
$\Delta V_{BR,LP}$	Voltage drop over bus rectifier ($V_{BUS} - V_B$) with $I_{BUS} = 3 \text{ mA}$ and external Schottky diodes (Note 8)			0.35	V
$I_{STC,LP}$	Max Current available for the application to draw from STC and V_{DD} (including current drawn from V_{DD}) (Note 10)	R_{IDD} (Note 9) = 30 k Ω	2.0	2.3	mA
		(Note 9) = 13 k Ω	4.1	4.8	
$V_{STC,CLAMP,LP}$	Clamp voltage on pin STC ($I_{DD} < I_{STC}$) (Note 11)	9.4	10.5	11.5	V

7. All voltages are referenced to GND
8. Forward voltage of 0.3 V max
9. Resistor with 1% accuracy
10. When configured in low power mode, the current limit of CS1 is set to 2 x the mark current level in M-BUS mode. The NCN5151 does not behave as a current source but as current limiter because V_{STC} never reaches the STC clamp level.
11. The STC clamp function protects the STC capacitor in case 2WLPM or 3WLPM is accidentally enabled during regular M-Bus operation.

Table 7. GENERAL – ELECTRICAL CHARACTERISTICS (Note 12)

Symbol	Parameter	Min	Typ	Max	Unit
I_{CC}	Internal Supply Current (R_{IDD} (Note 13) = 13k Ω , $R_X/R_{XI} = \text{mark}$)	–	250	500	μA
I_{IO}	Current drawn by the V_{IO} pin	–0.5	–	0.5	μA
V_{RIDD}	Voltage on RIDD pin	1.15	1.2	1.25	V

12. All voltages are referenced to GND
13. Resistor with 1% accuracy

Table 8. VDD REGULATOR ELECTRICAL CHARACTERISTICS (Note 14)

Symbol	Parameter		Min	Typ	Max	Unit
V _{DD}	Voltage on V _{DD} (I _{DD} < 15 mA)		3.1	3.3	3.6	V
I _{DD}	Peak current that can be supplied by V _{DD} Note 15 with condition V _{STC} > 3.8 V		15	–	–	mA
I _{DD, OFF}	V _{BUS} = 0 V, V _{STC} = 0 V		–0.5	–	0.5	μA
V _{POR, ON}	Power-on reset threshold to connect V _{DD}		2.65	2.85	3.15	V
V _{POR, OFF}	Power-on reset threshold to disconnect V _{DD}		2.55	2.75	3.00	V
V _{STC,VDDON}	Threshold voltage on pin STC to turn on V _{DD} regulator and pull high PF pin.	PMODE high (VB > 10.6 V) M-Bus Mode	5.6	6.0	6.4	V
		PMODE low (VB < 10.6 V) Low Power Mode	3.1	3.4	3.6	V
V _{STC,VDDOFF}	Threshold voltage on pin STC to turn off V _{DD} regulator and pull low PF pin		2.7	3.0	3.2	V

14. All voltages are referenced to GND

15. Average current draw limited by I_{STC}

Table 9. M-BUS RECEIVER ELECTRICAL CHARACTERISTICS (Note 16)

Symbol	Parameter	Min	Typ	Max	Unit
V _T	Receiver threshold voltage	Mark – 8.2		Mark – 5.7	V
V _{SC}	Mark level storage capacitor voltage			V _B	V
I _{SC, charge}	Mark level storage capacitor charge current	–40	–25	–15	μA
I _{SC, discharge}	Mark level storage capacitor discharge current	0.3	0.6	–0.033 x I _{SC, charge}	μA
CDR	Charge/Discharge current ratio	30	40	–	
V _{TX,OH1} V _{TXI,OH1}	TX/TXI high-level voltage (I _{TX} /I _{TXI} = –100 μA) (Note 17)	V _{IO} – 0.6	–	V _{IO}	V
V _{TXI,OL1} V _{TX,OL1}	TX/TXI low-level voltage (I _{TX} /I _{TXI} = 100 μA)	0	0.20	0.35	V
V _{TX,OL2}	TX/TXI low-level voltage (I _{TXI} = 1.1 mA)	–	1	1.5	V
I _{TX} , I _{TXI}	V _{TX} = 7.5 V, V _{STC} = 6 V	0	11	16	μA

16. All voltages are referenced to GND

17. V_{STC} > V_{IO} + 1 V

Table 10. LOW POWER MODE RECEIVER ELECTRICAL CHARACTERISTICS (Note 18)

Symbol	Parameter	Min	Typ	Max	Unit
V _{TL,LP}	Receiver low threshold voltage (Falling V _{BUS})	1.2	1.6	2.4	V
V _{TH,LP}	Receiver high threshold voltage (Rising V _{BUS})	1.5	2	2.7	V
V _{TX,OH2} V _{TXI,OH2}	TX/TXI high-level output voltage (I _{TX} /I _{TXI} = –100 μA) with V _{STC} ≥ V _{IO} + 0.7 V	V _{IO} – 0.75	V _{IO} – 0.6	V _{IO}	V
V _{TX,OH3} V _{TXI,OH3}	TX/TXI high-level output voltage (I _{TX} /I _{TXI} = –50 μA) with V _{STC} ≥ V _{IO} + 0.5 V	V _{IO} – 0.6	V _{IO} – 0.45	V _{IO}	V
V _{TXI,OL3} V _{TX,OL3}	TX/TXI low-level output voltage (I _{TX} /I _{TXI} = 100 μA)	0	0.20	0.35	V

18. All voltages are referenced to GND

Table 11. M-BUS TRANSMITTER ELECTRICAL CHARACTERISTICS (Note 19)

Symbol	Parameter	Min	Typ	Max	Unit
I_{MC}	Space level modulating current with $R_{RIS} = 100 \Omega$ (Note 20)	12.5	15	18	mA
V_{RIS}	Voltage on RIS pin	1.2	1.4	1.6	V
$V_{RX,IH}$, $V_{RXI,IH}$	RX/RXI high-level input voltage	$V_{IO} - 0.8$		5.5	V
$V_{RX,IL}$, $V_{RXI,IL}$	RX/RXI low-level input voltage	0		0.8	V
I_{RX} , I_{RXI}	Current drawn from RX/RXI pins (Note 21) ($V_{IO} = 3 V$)	± 6		± 30	μA

19. All voltages are referenced to GND

20. Resistor with 1% accuracy

21. Including internal pull-up resistor on RX and internal pull-down resistor on RXI

Table 12. LOW POWER MODE TRANSMITTER ELECTRICAL CHARACTERISTICS (Note 22)

Symbol	Parameter	Min	Typ	Max	Unit
2-WIRE LOW POWER MODE					
$I_{TX,2WLPM}$	Transmission current with $R_{RIS} = 100 \Omega$ (Note 23)	8.5	10	11.5	mA
$V_{RIS,2WLPM}$	Voltage on RIS pin	0.85	1.00	1.15	V
3-WIRE LOW POWER MODE					
$V_{OD,OL}$	OD low-level output voltage, $I_{OD} = 2 mA$	0	0.1	0.3	V
$I_{LEAK,OD}$	OD leakage current, $V_{OD} = 10 V$	0	–	1	μA

22. All voltages are referenced to GND

23. Resistor with 1% accuracy

Table 13. VB MONITOR ELECTRICAL CHARACTERISTICS (Note 24)

Symbol	Parameter	Min	Typ	Max	Unit
$V_{VB,PMODE}$	VB voltage level to enable PMODE pin	8.0	9.4	10.5	V
$V_{PMODE,OH}$	PMODE high-level output voltage, $I_{PMODE} = -50 \mu A$	$V_{DD} - 0.3$	–	V_{DD}	V
$V_{PMODE,OL}$	PMODE low-level output voltage, $I_{PMODE} = 50 \mu A$	0	–	0.3	V

24. All voltages are referenced to GND

Table 14. 2WLPM and 3WLPM INPUT CHARACTERISTICS (Note 25)

Symbol	Parameter	Min	Typ	Max	Unit
$I_{2WLPM,IL}$ $I_{3WLPM,IL}$	2WLPM / 3WLPM pull-down current, (voltage range: 0.2 to 3.3 V)		2		μA
$V_{2WLPM,IL}$ $V_{3WLPM,IL}$	2WLPM / 3WLPM low-level input voltage	0	–	0.2 x V_{DD}	V
$V_{2WLPM,IH}$ $V_{3WLPM,IH}$	2WLPM / 3WLPM high-level input voltage	0.8 x V_{DD}	–	V_{DD}	V

25. All voltages are referenced to GND

NCN5151

Table 15. 2WLPM, 3WLPM, and OD TRUTH TABLE

2WLPM	3WLPM	Operating Mode	OD
L	L	M-Bus	HiZ
L	H	3 Wire Low Power Mode	Space (Note 26) state: Low Mark (Note 27) state: HiZ
H	L	2 Wire Low Power Mode	High Impedance
H	H	Not Valid (Note 28)	Space state: Low Mark state: HiZ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

26. "Space" state means RX "0" or RXI "1"

27. "Mark" state means RX "1" or RXI "0"

28. Note 2WLPM and 3WLPM both High is not a valid combination. This state is not destructive for the NCN5151 device, but the communication will fail

APPLICATION SCHEMATICS – M-BUS APPLICATION ONLY

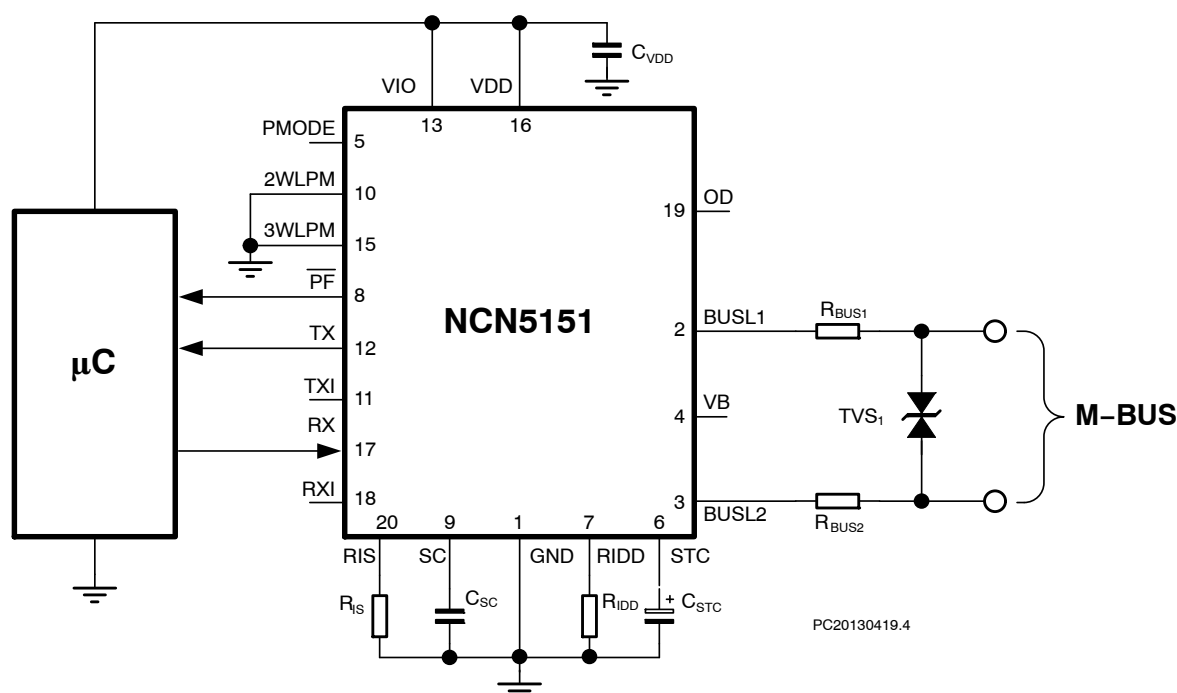


Figure 3. General Application Schematic

NCN5151

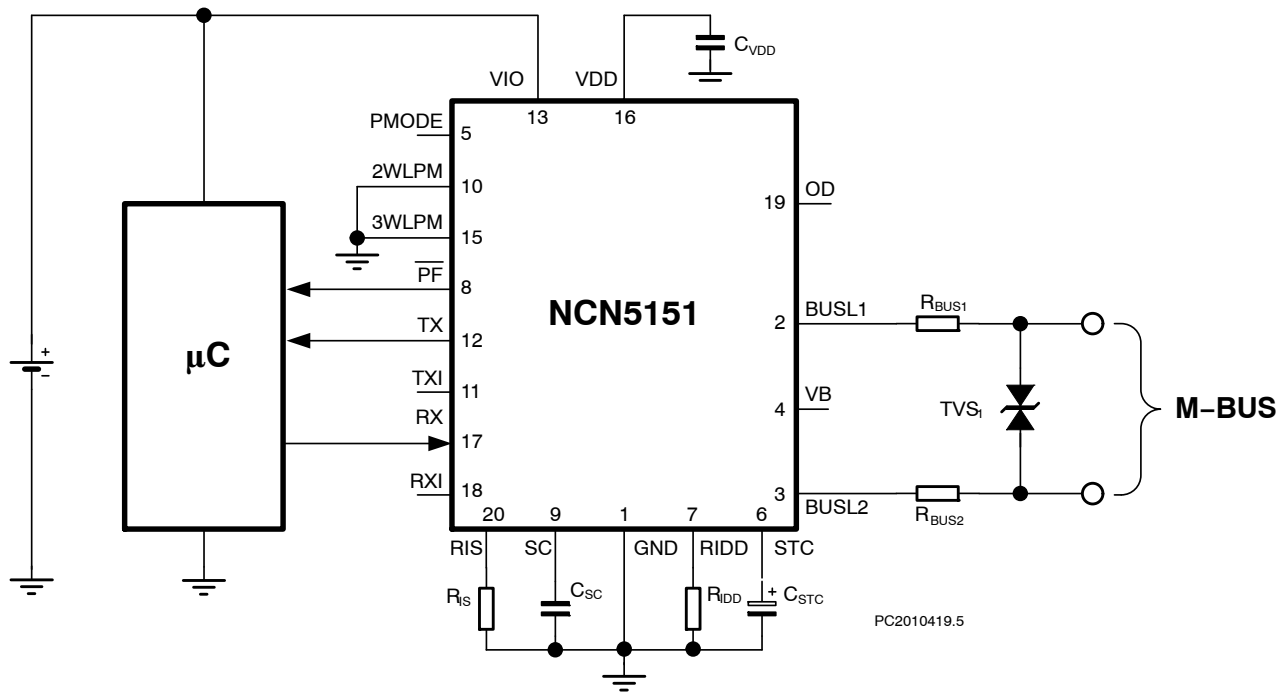


Figure 4. Application Schematic with External Power Supply

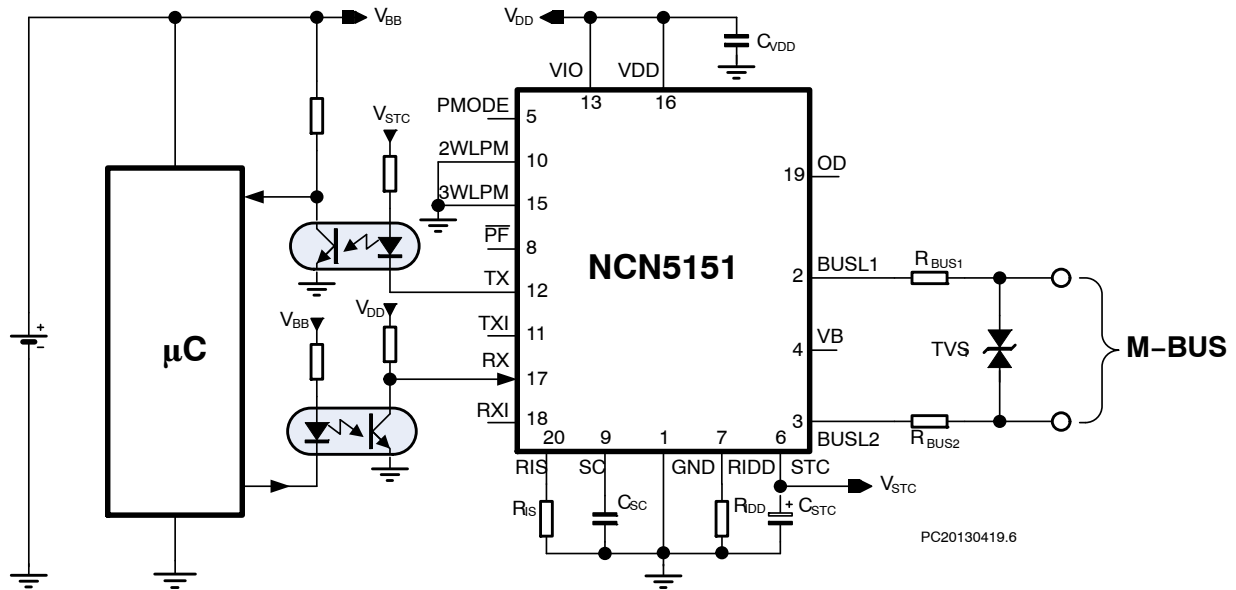


Figure 5. Optically Isolated Application Schematic

Table 16. TYPICAL BILL OF MATERIALS – M-BUS MODE

Reference Designator	Value (Typical)	Tolerance	Manufacturer	Part Number
U ₁			onsemi	NCN5151
TVS ₁	40 V		onsemi	1SMA40CAT3G
C _{VDD}	≥1 μF	-20%, +80%		
R _{IS}	100Ω	1%		

Table 16. TYPICAL BILL OF MATERIALS – M-BUS MODE

Reference Designator		Value (Typical)	Tolerance	Manufacturer	Part Number
C_{SC}		220 nF	-20%, +80%		
R_{BUS1}, R_{BUS2}		220 Ω	10%		
R_{IDD}	1 UL	30 k Ω	1%		
	2 UL	13 k Ω	1%		
	3 UL (Note 29)	8.45 k Ω	1%		
	4 UL (Note 29)	6.19 k Ω	1%		
	5 UL (Note 29)	4.87 k Ω	1%		
	6 UL (Note 29)	4.02 k Ω	1%		
C_{STC}	1 UL	<330 μ F	10%		
	2 UL	<680 μ F	10%		
	3 UL (Note 29)	<1000 μ F	10%		
	4 UL (Note 29)	<1500 μ F	10%		
	5 UL (Note 29)	<2200 μ F	10%		
	6 UL (Note 29)	<2200 μ F	10%		

29.3–6 UL configurations are only possible for the NQFP variant.

APPLICATION INFORMATION – M-BUS MODE

This section provides some information related to M-bus mode application.

The NCN5151 is a slave transceiver for use in the M-Bus protocol. The bus connection is fully polarity independent. The transceiver will translate the bus voltage modulation from master-to-slave communication to TTL UART communication, and in the other direction translate UART voltage levels to bus current modulation. The transceiver also integrates a voltage regulator for utilizing the current drawn in this way from the bus, and an early power fail warning. The transceiver also supports an external power supply and the I/O high level can be set to match the slave sensor circuit. A complete block diagram is shown in Figure 2. Each section will be explained in more detail below.

M-Bus Protocol

M-BUS is a European standard for communication and powering of utility meters and other sensors. Communication from master to slave is achieved by voltage-level signaling. The master will apply a nominal +36 V to the bus in idle state, or when transmitting a logical 1 (“mark”). When transmitting a logical 0 (“space”), the master will drop the bus voltage to a nominal +24 V. Communication from the slave to the master is achieved by current modulation. In idle mode or when transmitting a logical 1 (“mark”), the slave will draw a fixed current from the bus. When transmitting a logical 0 (“space”), the slave will draw an extra nominal 15 mA from the bus. M-BUS uses a half-duplex 11-bit UART frame format, with 1 start bit, 8 data bits, 1 even parity bit and a stop bit. Communication speeds allowed by the M-BUS standard are 300, 600, 2400, 4800, 9600, 19200 and 38400 baud, all of which are supported by the NCN5151.

Bus Connection and Rectification

The bus should be connected to the pins BUSL1 and BUSL2 through series resistors to limit the current drawn from the bus in case of failure (according to the M-BUS standard). Typically, two 220 Ω resistors are used for this purpose.

Since the M-BUS connection is polarity independent, the NCN5151 will first rectify the bus voltage through a semi-active bridge rectifier.

Slave Power Supply (Bus Powered)

A slave device can be powered by the M-BUS or from an external supply. The M-BUS standard requires the slave to draw a fixed current from the bus. This is accomplished by the constant current source CS1. This current is used to charge the external storage capacitor C_{STC}. The current drawn from the bus is defined by the programming resistor R_{IDD}. The bus current can be chosen in increments of

1.5 mA called unit loads. Table 5 lists the different values of programming resistors needed for different unit loads, as well as the current drawn from the bus (I_{BUS}) and the current that can be drawn from the STC pin (I_{STC}). I_{STC} is slightly less than I_{BUS} to account for the internal power consumption of the NCN5151.

The resistors R_{IDD} used must be at least 1% accurate. Note that using 5 and 6 Unit Loads is not covered by the M-BUS standard.

When the voltage on the STC pin reaches V_{STC,VDDON} the LDO is turned on, and will regulate the voltage on the VDD pin to 3.3 V, drawing current from the storage capacitor. A decoupling capacitor of minimum 1 μ F is required on the VDD pin for stability of the regulator. On the STC pin, a minimum capacitance of 10 μ F is required. Furthermore, the ratio C_{STC}/C_{VDD} must be larger than 9. The voltage on the STC pin is clamped to V_{STC} by a shunt regulator which will dissipate any excess current that is not used by the NCN5151 or external circuits.

Slave Power Supply (External Battery)

In case the external sensor circuit consumes more than the allowed bus current or the sensor should be kept operational when the bus is not present, an external power supply, such as a battery, is required (Figure 4).

When the external circuitry uses different logical voltage levels, simply connect the power supply of that voltage level to VIO, so that the RX, RXI, TX, TXI and $\overline{\text{PF}}$ pins will respond to the correct voltage levels. The NCN5151 will still be powered from the bus, but all communication will be translated to the voltage level of VIO.

Contrary to the NCN5150, the NCN5151 does not support the remote supply/Battery support because of the V_{STC,VDDOFF} level which has been lowered below 3.3 V for low bus voltage operation.

Communication, Master to Slave

M-BUS communication from master to slave is based on voltage level signaling. To differentiate between master signaling and voltage drop caused by the signaling of another slave over cabling resistance, etc., the mark level

V_{MARK} is stored, and only when the bus voltage drops to less than V_T will the NCN5151 detect communication. A simplified schematic of the receiver is shown in Figure 7. The received data is transmitted on the pins TX and TXI, as shown in the waveforms in Figure 6.

An external capacitor must be connected to the SC pin to store the mark voltage level. This capacitor is charged to V_S.

Discharging of this capacitor is typically 40x slower, so that the voltage on SC drops only a little during the time the master is transmitting a space. The value of C_{SC} must be chosen in the range of 100 nF – 330 nF.

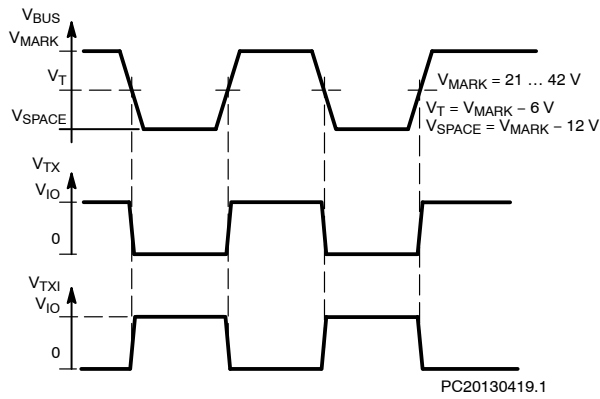


Figure 6. Master to Slave Communication

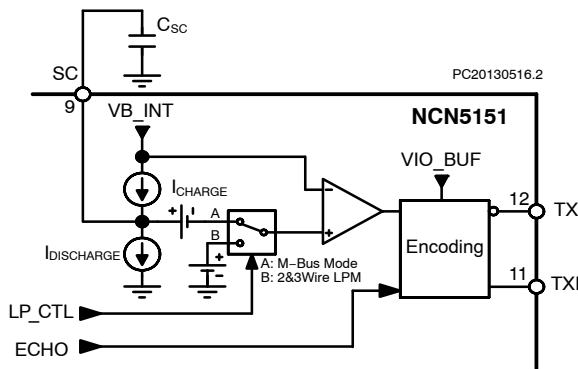


Figure 7. Receiver Block

Communication, Slave to Master

M-BUS communication from slave to master uses bus current level modulation while the voltage remains constant. This current modulation can be controlled from either the RX or RXI pin as shown in Figures 8 and 9. When transmitting a space ("0"), the current modulator will draw an additional current from the bus. This current can be set with a programming resistor R_{RIS} . To achieve the space current required the M-BUS standard, R_{RIS} should be 100 Ω . A simplified schematic of the transmitter is shown in Figure 10.

Because the M-BUS protocol is specified as half-duplex, an echo function will cause the transmitted signal on RX or RXI to appear on the receiver outputs TX and TXI. Should the master attempt to send at the same time, the bitwise added signal of both sources will appear on these pins, resulting in invalid data.

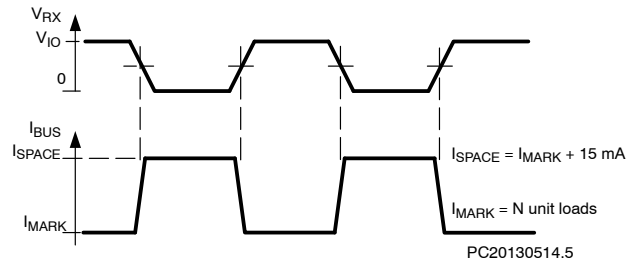


Figure 8. Slave to Master Communication Driving RX

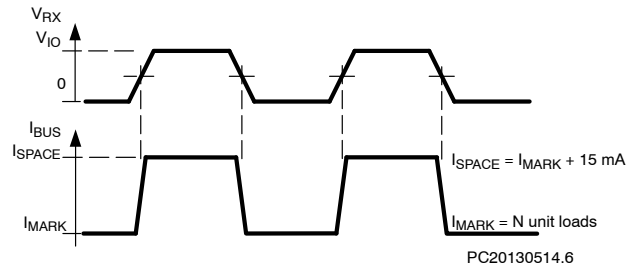


Figure 9. Slave to Master Communication Driving RXI

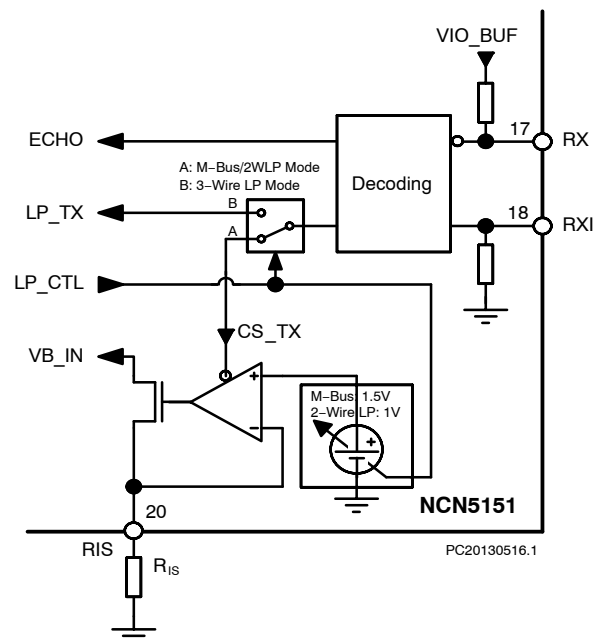


Figure 10. Transmitter Block

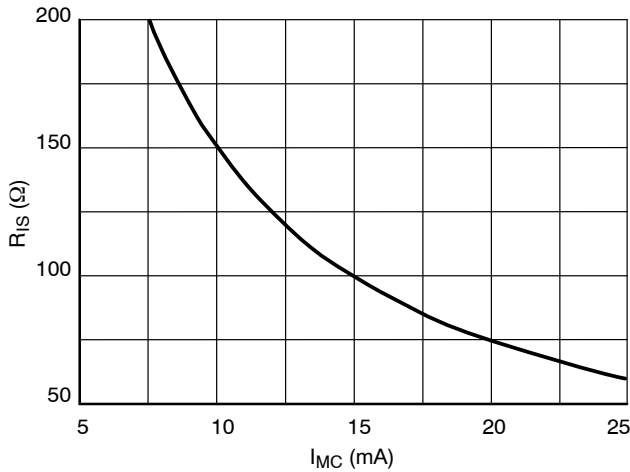


Figure 11. Typical Modulation Current and RIS Resistor

Power On/Off Sequence and Power Fail Indicator

The power-on and power-off sequence of the NCN5150 is shown in Figure 12. Shown also in Figure 12 is the operation of the $\overline{\text{PF}}$ pin. This pin is used to give an early warning to the microcontroller that the bus power is collapsing, allowing the microcontroller to save its data and shut down gracefully. The times t_{on} and t_{off} can be approximated by the following formulas:

$$t_{\text{on}} = \frac{C_{\text{STC}}}{I_{\text{STC}}} V_{\text{STC,VDDON}}$$

$$t_{\text{off}} = \frac{C_{\text{STC}}}{I_{\text{DD}} + I_{\text{STC}}} (V_{\text{STC,CLAMP}} - V_{\text{STC,VDDOFF}})$$

Where I_{CC} is the internal current consumption of the NCN5151 and I_{DD} is the current consumed by external circuits drawn from either VDD or STC. These formulas can

be used to dimension the value of the bulk C_{STC} needed, taking into account that the M-BUS standard requires t_{on} to be less than 3 s.

For certain applications where the power drawn from the bus is not used in external circuits, the storage capacitor value can be much lower. The NCN5151 requires a minimum STC capacitance of 10 μF (and $C_{\text{STC}}/C_{\text{VDD}} > 9$) to ensure that the bus current regulation is stable under all conditions.

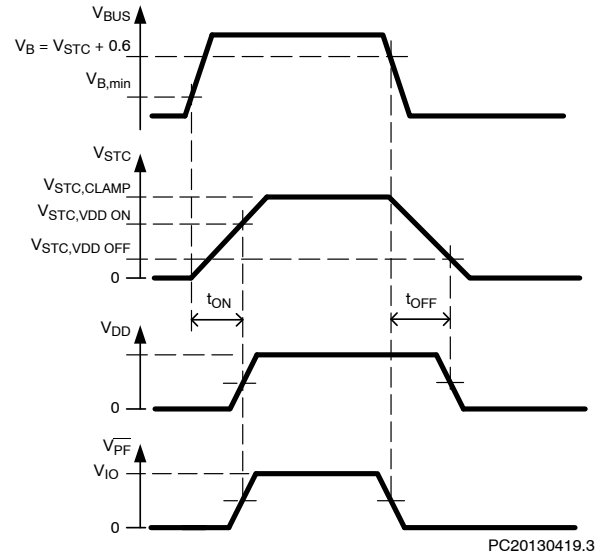


Figure 12. Power-on and Power-off

Thermal Shutdown

The NCN5151 includes a thermal shutdown function disabling the transmitter in case of excessive junction temperature.

NCN5151

APPLICATION SCHEMATICS LOW-POWER MODE AND M-BUS APPLICATIONS

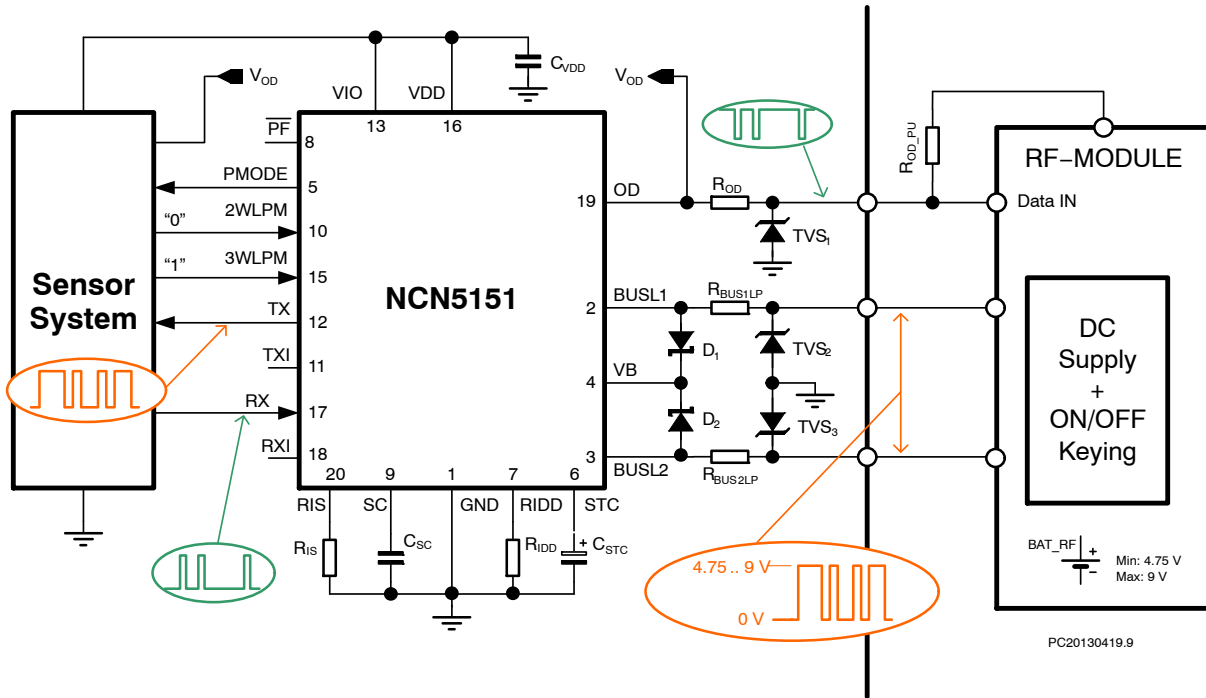


Figure 13. 3-Wire Low Power Mode and M-Bus Application Schematic

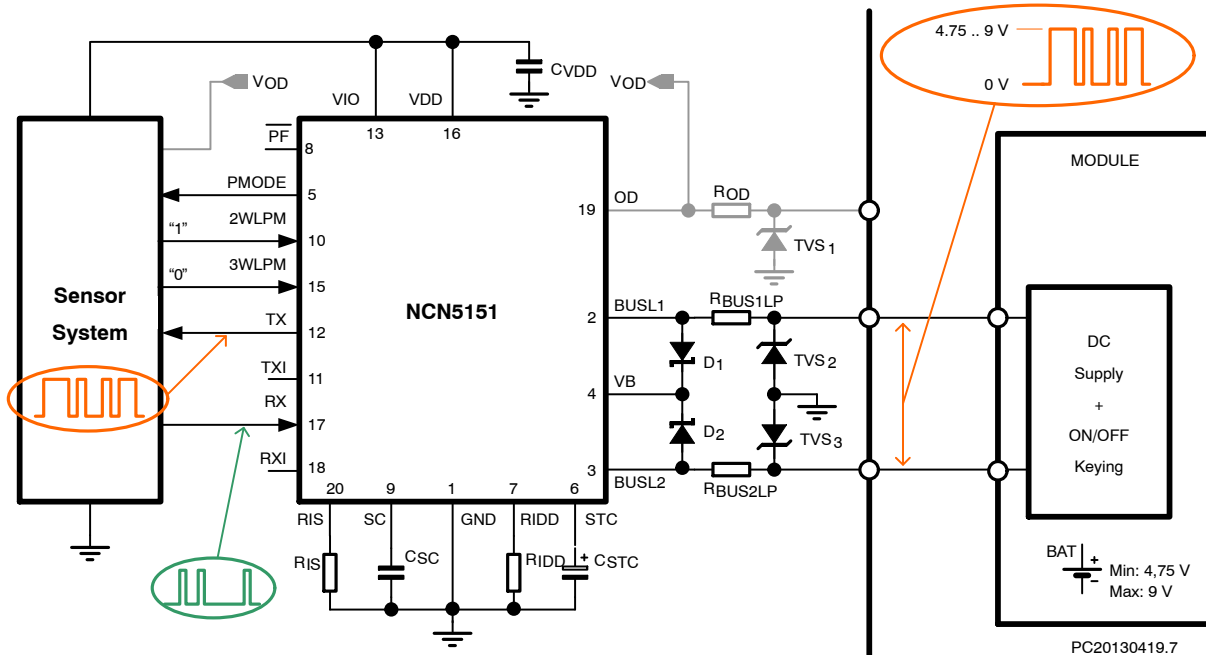


Figure 14. 2-Wire Low Power Mode and M-Bus Application Schematic

Table 17. TYPICAL BILL OF MATERIALS – LOW POWER MODE

Reference Designator	Value (Typical)	Tolerance	Manufacturer	Part Number	Note
U ₁			onsemi	NCN5151	
TVS ₁	40 V		onsemi	1SMA40AT3G	
TVS ₂	30 V		onsemi	1SMA30AT3G	
D1, D2			onsemi	BAS70LT1G	Absolute maximum reverse voltage >40 V
C _{VDD}	≥1 μF	–20%, +80%			
R _{IS}	100 Ω	1%			
C _{SC}	220 nF	–20%, +80%			
R _{BUS1LP} , R _{BUS2LP}	33 Ω		Murata	PRG18B330MB1RB	Over-current protection resistor type are recommended for Low Power Modes
R _{OD}	560 Ω	10%			
R _{IDD}	1 U _L	30 kΩ	1%		
	2 U _L	13 kΩ	1%		
C _{STC}	1 U _L	<330 μF	10%		Min : 22 μF with C _{STC} / C _{VDD} > 9
	2 U _L	<680 μF	10%		

APPLICATION INFORMATION – LOW POWER MODE

3-Wire LP Mode – RF Module – Bidirectional

This section provides some information related to the NCN5151 operating in Low Power mode. As depicted in Figure 13, the NCN5151 also offers the possibility to build an extremely low power communication with an external RF Module.

This topology uses a 3-wire interface: the regular bus lines (BUSL1, BUSL2) and the open drain pin (OD).

This three-wire interface is designed in such a way that when the system is switched on, the Sensor System detects via the third contact V_{OD} whether any direct connection with the external battery module exists. If this is the case, the Sensor System enables the 3WLPM (three-wire low power mode) pin. The low power logic changes the operating mode of the transmitter block (Figures 2 and 10). The communication from slave to RF module does not take place via energy-intensive current modulation, but instead by means of a purely digital signal on the OD pin. This enables extremely energy-saving communication with the master.

As with the M-Bus, the RF module signals the data to the NCN5151 through voltage modulation but in this case this is purely ON/OFF keying. This means the power supply (maximum of 9 V) is simply switched on and off. As illustrated in Figure 7 the receiver threshold switches to a level referenced to ground instead of the mark state. The sensor system has to make sure that it has sufficient energy to send data and save enough energy in a capacitor for this purpose. During communication from the RF module to the sensor, the sensor system must also have sufficient energy and buffer this if necessary. The power supply can be

between 4.75 and 9 V; two 3 V lithium batteries are normally used in a system like this.

Figure 17 illustrates this bidirectional communication in 3-wire LP mode.

The OD pin has to be protected against surge transients with a TVS and a series resistor R_{OD}. This resistor acts also as a current limiter in case of a short between the 9V battery module and the wire “Data_In” going to the OD connector, while 3WLPM and RX/RXI are active. The current through the OD pin is limited to 20 mA. Therefore a typical R_{OD} resistor of 560 Ω is recommended. (Note that the internal OD switch has a typical R_{DS(on)} of 50 Ω)

2-Wire LP Mode – SCR – Bidirectional

The second low power mode works with a 2-wire interface also called SCR (System for meter Communication and Readout for powerless meters) which is enabled with the 2WLPM input pin (see Figure 14).

The communication from master to slave is done with ON/OFF keying similar to 3-wire LP mode, but the communication from slave to master uses current modulation similar to the current modulation used in the M-Bus protocol. In order to handle the low supply voltage (down to 4.75 V) and limit voltage losses, the current modulation amplitude is reduced with 33% (10 mA vs 15 mA) as illustrated in Figure 10.

Figure 18 illustrates the bidirectional communication in 2-wire LP mode.

Precautions regarding the stored energy during ON/OFF keying are also valid for this mode

MBUS and Low Power Mode Recognition

The NCN5151 includes a VB voltage monitor with an output pin PMODE (Power Mode) indicating whether VB voltage is above 9.5 V typical. This information is sent to the sensor system which determines the relevant mode (using the OD state pin): M-Bus, 2-wire or 3-wire low power mode. The sensor system then signals the NCN5151 the chosen operating mode using 2WLPM and 3WLPM pins (see Figures 15 and 16). During 2WLPM or 3WLPM the $\overline{\text{PF}}$ output is disabled and pulled to ground.

By keeping the selection mode mechanism outside the NCN5151, the user can enhance the meter application robustness and its reliability through the sensor system firmware based on their application environment.

Table 15 gives an overview of the low power pin truth table. Note that both 2WLPM and 3WLPM pins enabled is not allowed. This combination is safe for the NCN5151 but the communication with the master may fail.

CS1 Current Source and STC Clamp

Contrary to M-BUS mode, in low power mode the NCN5151 does not behave as a constant current load. The STC clamp level ($V_{\text{STC,CLAMP,LP}}$) is increased higher than the low power mode supply (9.5 V typical) in order to never trigger it under normal operating range. Thus the CS1 will only act as current limiter during startup and ON/OFF keying and in steady state the CS1 block will be pinched off between STC and VB.

This current limit in low power mode is double compared to the M-BUS mode (Table 6, Figures 15 and 16). This allows a faster recharge of C_{STC} during ON/OFF keying and a duty cycle close to 50%.

Low Power Mode and Minimum Operating Voltage

The user should take several precautions when using the low power modes in order to maximize the voltage seen by the NCN5151 circuitry.

It is required to replace the 220 Ω bus resistors with current limiting resistor (33 Ω typ, PTC type with rapid operation). This will significantly reduce the voltage drop, especially during current modulation (slave to master) in 2WLPM and guarantee sufficient short protection.

An external Schottky (with forward voltage of 0.3 V max) is also required between BUSL1/BUSL2 and the VB pin in order to reduce the overall voltage drop on the internal diode bridge.

These adaptations allow the NCN5151 to operate in low power mode with a minimum battery voltage of 4.75 V.

As mentioned in both low power mode sections, it is important to maintain a minimum voltage level on the STC pin during the ON/OFF keying. Below 3.8 V on STC, the low dropout regulator may not be able to regulate the VDD supply pin correctly.

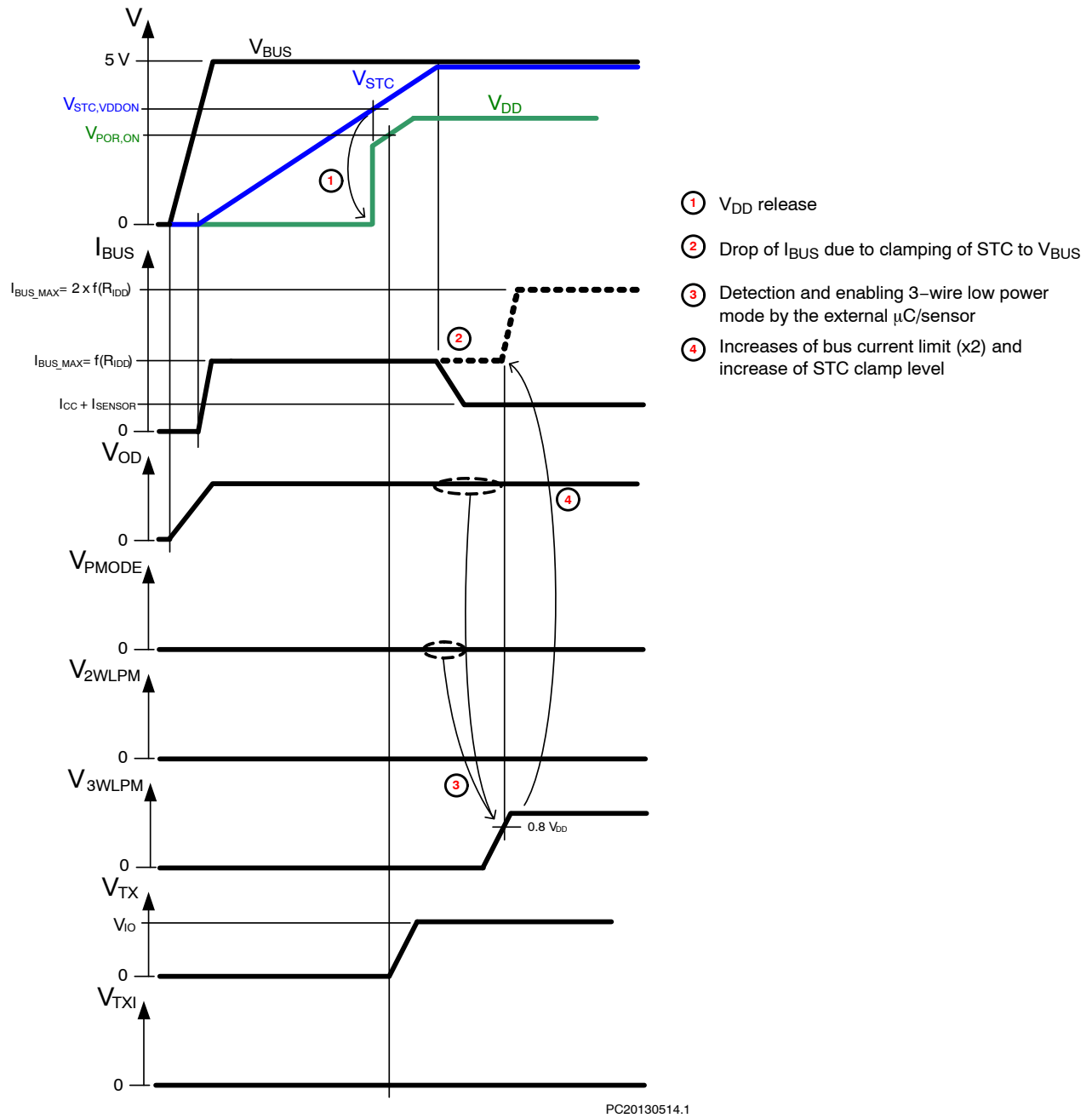


Figure 15. Startup Sequence in 3-Wire Low Power Mode



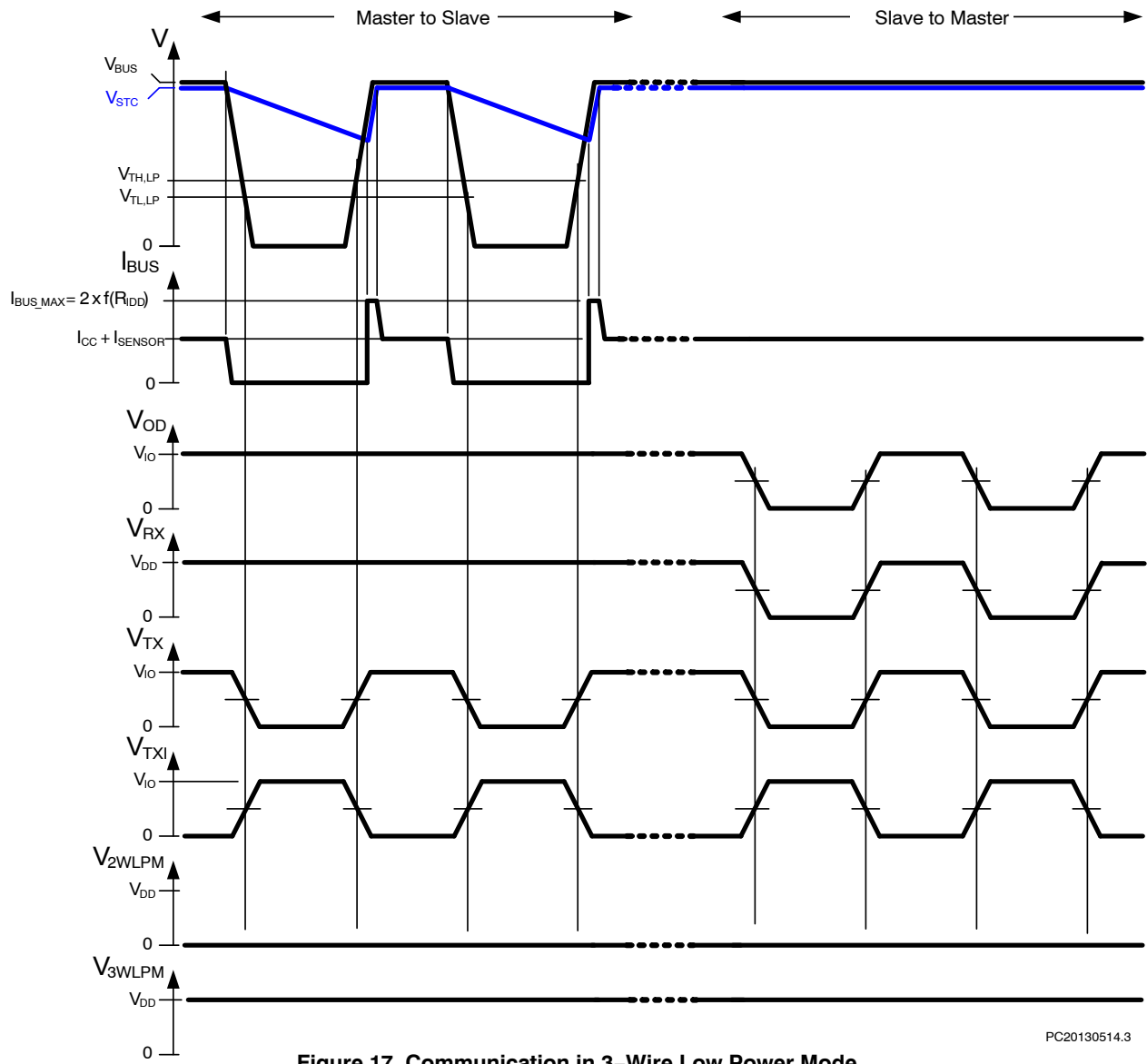


Figure 17. Communication in 3-Wire Low Power Mode

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NCN5151

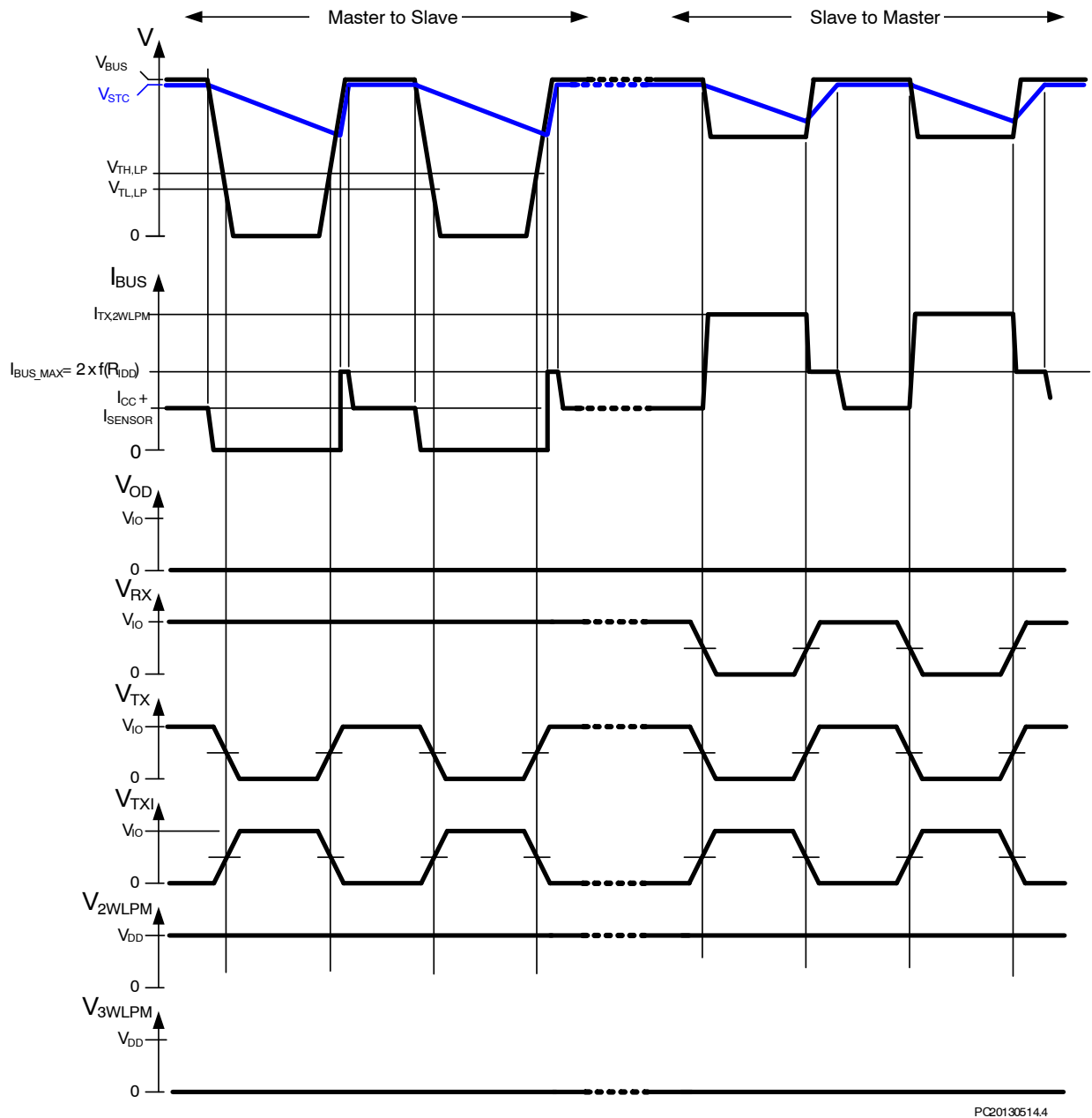


Figure 18. Communication in 2-Wire Low Power Mode

Table 18. ORDERING INFORMATION

Device	Package	Shipping [†]
NCN5151MNTWG	NQFP20, 4x4 (Pb-Free)	2500 / Tape & Reel

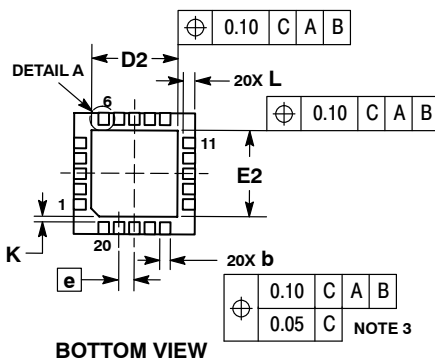
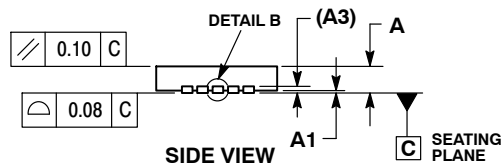
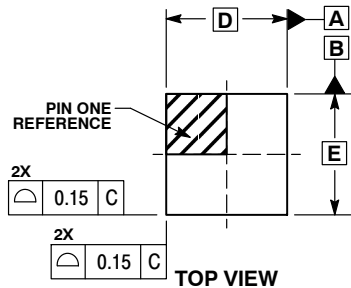
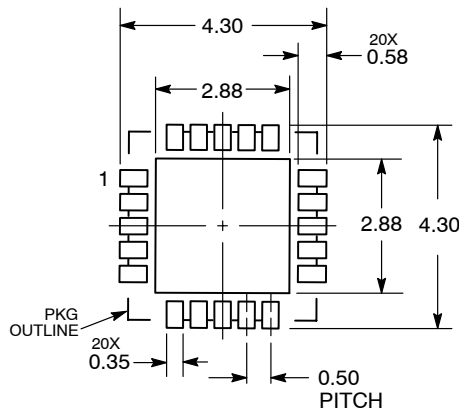
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



SCALE 2:1

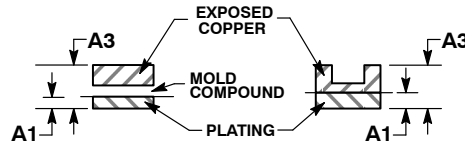
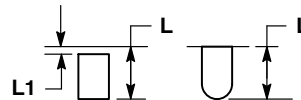
QFN20, 4x4, 0.5P
CASE 485E
ISSUE C

DATE 13 FEB 2018


SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS

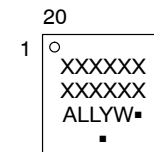
*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERM/D.


DETAIL B
ALTERNATE
CONSTRUCTIONS

DETAIL A
OPTIONAL CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.80	1.00
A1	---	0.05
A3	0.20 REF	
b	0.20	0.30
D	4.00 BSC	
D2	2.60	2.90
E	4.00 BSC	
E2	2.60	2.90
e	0.50 BSC	
K	0.20 REF	
L	0.35	0.45
L1	0.00	0.15

GENERIC
MARKING DIAGRAM*


XXXXXX= Specific Device Code
A = Assembly Location
LL = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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